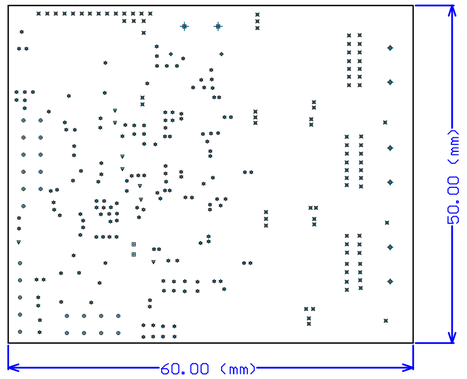
REV	ECO	Comments	Date



Symbol	Hit Count	Finished Hole Size	Plated	Hole Type
□	2	0.800mm (31.50mil)	PTH	Round
◇	2	1.000mm (39.37mil)	PTH	Round
⊠	2	2.540mm (100.00mil)	PTH	Round
⯐	6	1.700mm (66.93mil)	PTH	Round
▽	8	0.700mm (27.56mil)	PTH	Round
○	24	0.900mm (35.43mil)	PTH	Round
⌑	86	0.400mm (15.75mil)	PTH	Round
☼	162	0.300mm (11.81mil)	PTH	Round
	292 Total			

Layer	Name	Material	Thickness	Constant	Board Layer Stack
	Top Overlay				
	Top Solder	Solder Resist	0.010mm	3.5	
1	Top Layer		0.035mm		
	Dielectric1	FR-4	0.360mm	4.2	
2	Signal Layer 1		0.035mm		
	Dielectric 3	FR-4	0.710mm	4.2	
3	Signal Layer 2		0.035mm		
	Dielectric 2	FR-4	0.360mm	4.2	
4	Bottom Layer		0.035mm		
	Bottom Solder	Solder Resist	0.010mm	3.5	
	Bottom Overlay				

MICROCHIP
Microchip Technology Inc.
2355 W. Chandler Blvd.
Chandler, AZ 85224

TITLE: E-Scooter Reference Design (Three-Shunt)

PART NUMBER: INT01156

PCB DESIGNER: Cristian Papuc

GERBER FILE: Fab Drawing (Bottom,Top Layer)

ENGINEER: Cristian Papuc

BOARD NUMBER: 04-.ProjectBoardNumber

DOCUMENT NUMBER: 04N-.ProjectBoardNumber

DATE: 2/4/2021

PCB FILE NAME: 01156.PcbDoc

LAYER NAME: FAB (M4) NOTES (M1)

REV: 2

10mm 400mil